

2020 EDITORIAL CALENDAR

Issue	Featured and New Product Coverage	Important Industry Events
January	Antennas, Cable Assemblies, Couplers, Test and Measurement	IEEE Radio & Wireless Symp. <i>San Antonio</i> , January 26 – 29 DesignCon , Santa Clara, January 28 – 30
February	Design Tools, Power Amplifiers Filters, Mil-Aero Products	Satellite 2020 , Washington, DC, March 9 - 12
March	Passive Components- Attenuators, DC Blocks/Bias Tees	WAMICON , Clearwater Beach, April 15 - 17 NAB , Las Vegas, April 19 – 22
April	Test & Measurement Tools Cable Assemblies, Integrated Assemblies	
May	Active Components, Switches, Mixers, Phase Shifters, IMS2020 Show Issue	IMS , Los Angeles, June 21 – 26
June	Frequency Control Components, Low Loss Cables, Design Tools Update	IEEE EMC + SIPI , Reno, July 27 - 31
July	Passive Components, Isolators, Circulators, Connectors, Antennas	IEEE Autotestcon , Washington, DC, August 26 – 29
August	Defense Electronics EDA, Automated Test, Test Cables, Signal Generators	EuMW , Utrecht, Netherlands, September 13 – 18
September	Millimeter Connectors and Components, Detectors	MILCOM , location TBD, October
October	Circuit Materials, Interconnects, Base Station Products, Network Analyzers, Mil-Spec Products	
November	Coaxial Adapters, Low Noise Amplifiers, Modular Test Equipment	AOC International , Washington DC, December 8 – 10
December	Passive Components, Couplers and Power Dividers, Crystal Oscillators, VCOs, YIG Oscillators	IEEE Radio & Wireless Symposium , location TBD, January 2021

Additional technical articles can be published in each issue, covering other topics

AD CLOSING DATES: 15th of the prior month (next business day if weekend)

AD MATERIAL DEADLINE: 20th of the prior month. Contact your advertising sales representative for extra time or special requirements

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Editorial Submissions

Regular Columns

Meetings & Events, In the News, Design Notes, High Frequency Applications

Press Releases

Press releases for our informational columns should be sent by the first of the month prior to the desired publication date (e.g., April 1 for the May issue). Late-breaking news can be accommodated, but please advise the editors of urgent items by telephone or e-mail.

tim@highfrequencyelectronics.com

Article Contributions

We encourage the submission of technical articles, application notes and other editorial contributions. These may be on the topics noted above, or any other subject of current interest. Contact us with article ideas:

tim@highfrequencyelectronics.com

How to Contact Us

Send press releases and other communications to our Associate Publisher.

tim@highfrequencyelectronics.com

Summit Technical Media LLC

PO Box 4291

Tequesta, FL 33469

Phone: 603-759-1840